

B¹ dioxide gas laser, and said carbon dioxide gas laser having substantially the same energy of irradiation from beginning to end, to make said hole.

Kindly add the following new claim:

B² 24. (New) A method of making a hole in a copper-clad board, in which a surface of the metallic-treatment layer of the copper-clad board recited in claim 1, which layer contains nickel as an essential element, is directly irradiated with a carbon dioxide gas laser having an energy sufficient for processing a copper foil by means of the pulse oscillation of the carbon dioxide gas laser, and said carbon dioxide gas laser having increasing energy of irradiation from beginning to end, to make said hole.
